

# Integrating Pixel Array Detectors

**Sol Gruner**  
**Dept. of Physics & CHESS**  
**Cornell University**

*Detector development group*

**Mark Tate**

**Alper Ercan**

**Dan Schuette**

**Darol Chamberlain**

**Lucas Koerner**

**Hugh Phillip**

*Former members*

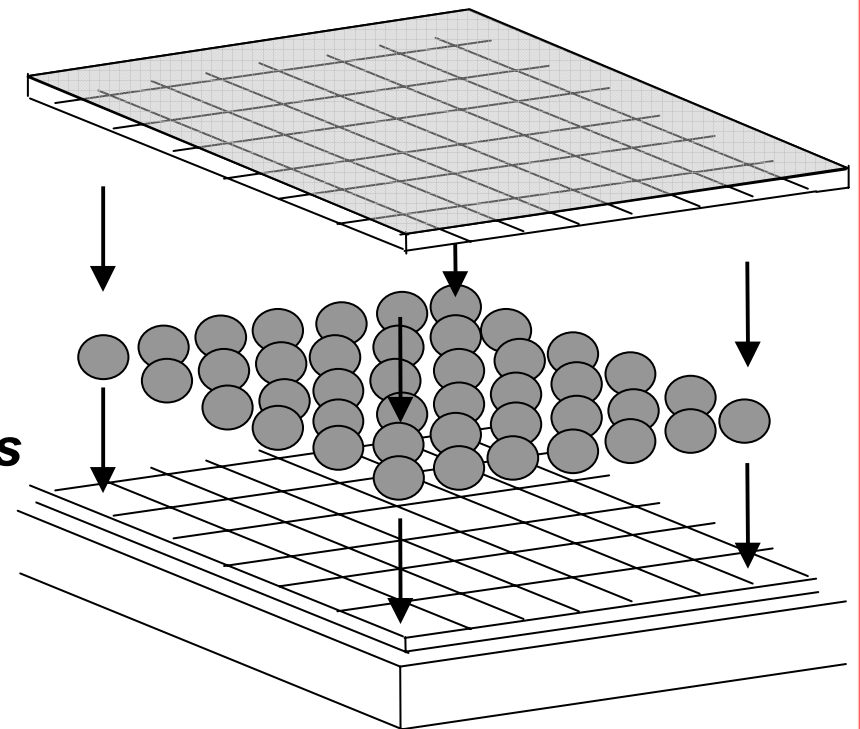
**Sandor Barna**

**Bob Wixted**

**Eric Eikenberry**

**Guisepppe Rossi**

**Matt Renzi**



# Basic Pixel Array Detector (PAD)

## Diode Detection Layer

- Fully depleted, high resistivity
- Direct x-ray conversion
- Silicon, GaAs, CdTe, etc.

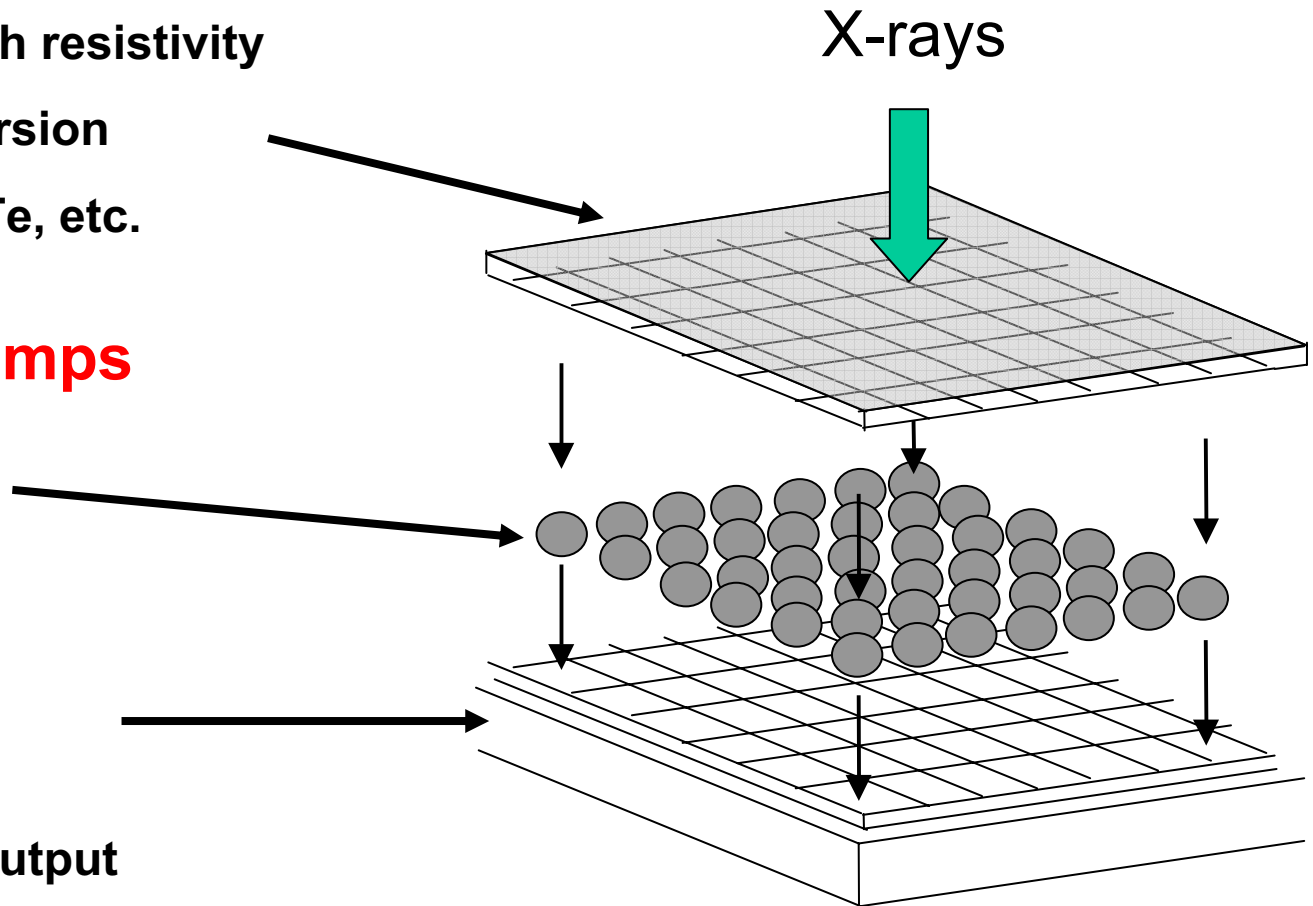
## Connecting Bumps

- Solder or indium
- 1 per pixel

## CMOS Layer

- Signal processing
- Signal storage & output

*Gives enormous flexibility!*



# Why Analog-Integrating?

## Some Common Sense Rules

**Rule #1: There is no universal detector. At best, a given detector is well-suited for a given application.**

- **Community needs are met by a spectrum of detectors optimized for different applications.**
- **Analog PADs meet specific needs. Examples will follow.**

# Why Analog-Integrating?

## Some Common Sense Rules

**Rule #2: The accuracy of a given measurement is not necessarily better or worse just because a photon-counting or an analog-integrating detector is used.**

**Accuracy depends on many real-world details of both the experiment and the detector, including:**

- **Calibrations**
- **Stability**
- **Photon loss due to, e.g., pixel signal-sharing, charge recombination, count-rate limitations, and x-ray absorption by inert structures**
- **Systematic effects, e.g., cross-talk, pickup noise**

**Analog-integrators have successfully demonstrated excellent performance to appropriate accuracy in certain experiments.**

# Why Analog-Integrating?

## Some Common Sense Rules

**Rule #3: Any detector is only as good as its calibration. In practice area detectors rarely achieve accuracies of 1%, and never better than a few tenths percent.**

**This is especially true for:**

- **Signals whose width is smaller than a pixel**
- **Very high local count-rates**

**For certain applications, analog-integrators have been very successfully calibrated.**

# Why Analog-Integrating?

## Some Common Sense Rules

**Rule #4: No matter how good you think a detector is, you are bound to be in for nasty surprises when you actually perform stringent performance tests.**

**Be skeptical of detector claims that are not backed up by appropriate, independently-repeated test data.**

**Analog-integrators have been around long enough that many of the nasty surprises are understood.**

## Analog-Integrating PADs are especially useful for...

- **Very high local count-rates. Examples:**
  - ✓ **Time-resolved radiography ( e.g.,  $>10^{10}$  x-ray/pix/sec)**
  - ✓ **Many XFEL & ERL applications (e.g., x-rays in femtoseconds)**
  - ✓ **Very low contrast imaging against high local backgrounds**

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  - ✓ Very low contrast imaging against high local backgrounds
- **Accurate measurements of small-sized signals. Examples:**
  - ✓ **Microcrystallography from low mosaic spread crystals.**
  - ✓ **Micro-radiography and tomography**
  - ✓ **Accurate difference imaging of spatially fine features.**



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- **Accurate measurements of small-sized signals. Examples:**
  - ✓ Microcrystallography from low mosaic spread crystals.
  - ✓ Micro-radiography and tomography
  - ✓ Accurate difference imaging for images with fine features.
- **Problems involving complex analog signal processing. Example:**
  - ✓ In-pixel time-correlation of images (e.g., high count-rate speckle experiments).

# Specific Example: High Speed Imaging

## Design Requirements

### Rapid Framing Imager

In pix storage for several frames

Selectable integration time ( $\mu\text{s}$  to seconds)

Dead time  $<$  few  $\mu\text{s}$

Well-depth  $> 10^4$  x-rays/pixel/frame (for 1% statistics)

Count rate  $> 10^{10}$  x-rays/pixel/s  Analog integration needed

Pixel size  $\leq 150 \mu\text{m}$  square

Standard CMOS fabrication service

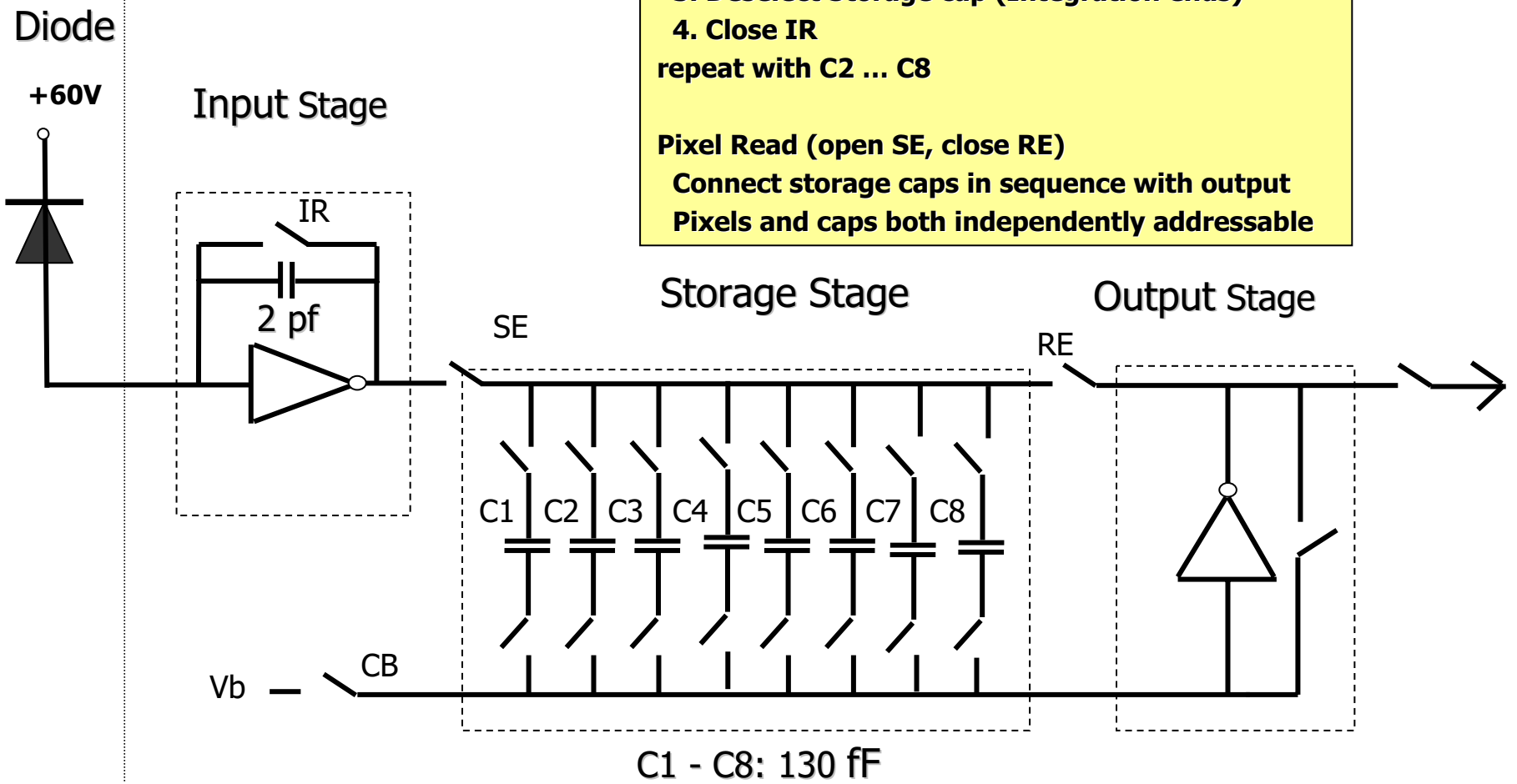
# Cornell Analog PAD

**Rapid framing (SE, IR closed)**

1. select storage cap C1
2. Open IR switch (Frame integration begins)
3. Deselect Storage cap (Integration ends)
4. Close IR

repeat with C2 ... C8

**Pixel Read (open SE, close RE)**  
 Connect storage caps in sequence with output  
 Pixels and caps both independently addressable

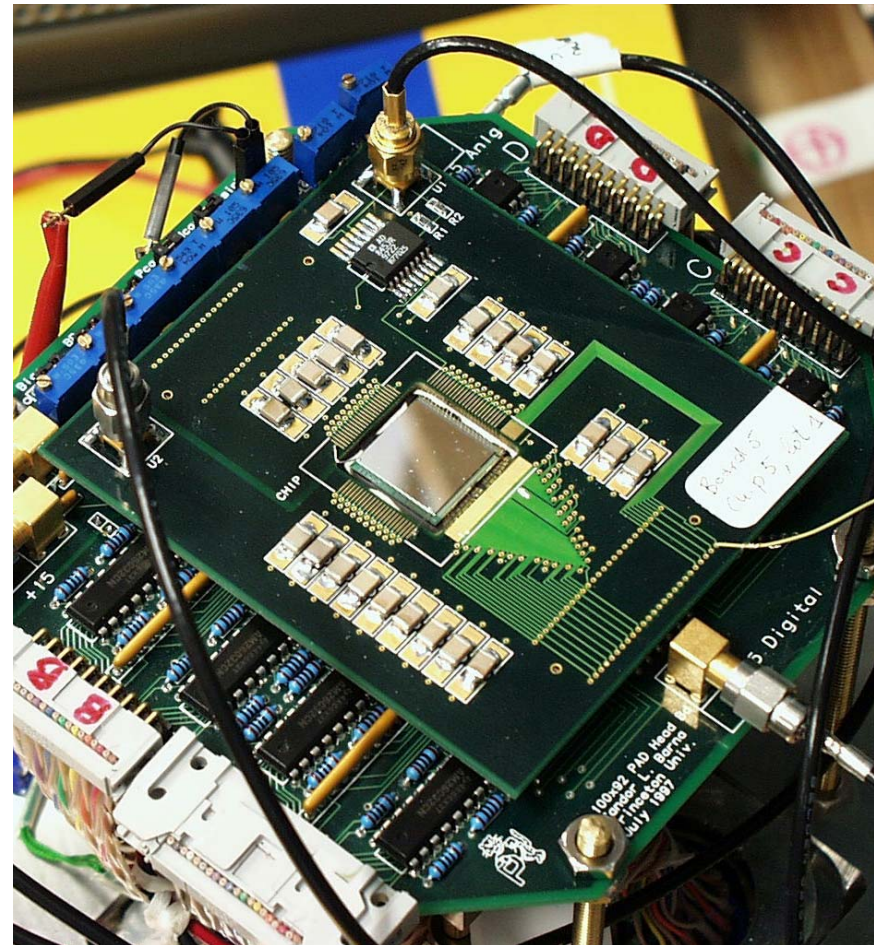


# Cornell 100x92 Analog PAD

1.2 mm HP CMOS process (MOSIS)  
(Linearized Capacitors)  
15 x 13.8 mm<sup>2</sup> active area; 100x92 pixels  
150 mm square pixel  
300 mm thick, high resistivity Si diode  
wafer (SINTEF)  
120 mm solder bump bond  
(GEC-Marconi)

100x92 PAD developers include:

Sandor Barna  
Eric Eikenberry  
Alper Ercan  
Sol Gruner  
Matt Renzi  
Giuseppe Rossi  
Mark Tate  
Bob Wixted



G. Rossi, *et al*, J Synchrotron Rad. (1999). **6**, 1095-1105.

# 100 x 92 Prototype Tests

## Test results with 8.9 keV x-rays

• Full well capacity (x-rays)	17000
• Non-linearity (% full well)	< 0.5 %
• RMS read noise : (x-rays/pixel)	2.0 – 2.8
• Dark current (-20 C) (x-ray/pixel/s) (fA/pixel)	1.6 – 7.7 6 – 40
• Storage capacitor leakage	0.07% / s
• PSF (@75 $\mu$ m)	< 1%
• X-rays stopped in diode	97 %
• Minimum integration period ( $\mu$ s)	0.15
• Minimum deadtime between frames ( $\mu$ s)	0.6
• Rad damage threshold (kRad, CMOS oxide)	30
• Tolerable radiation dose (kRad)	>300

# High speed radiography: Supersonic spray from diesel fuel injector

## X-ray beam

- CHESS Beamline D-1
- 6 keV (1% bandpass)
- 2.5 mm x 13.5 mm (step sample to tile large area)
- $10^8 - 10^9$  x-rays/pix/s
- 5.13  $\mu$ s integration (2x ring period)

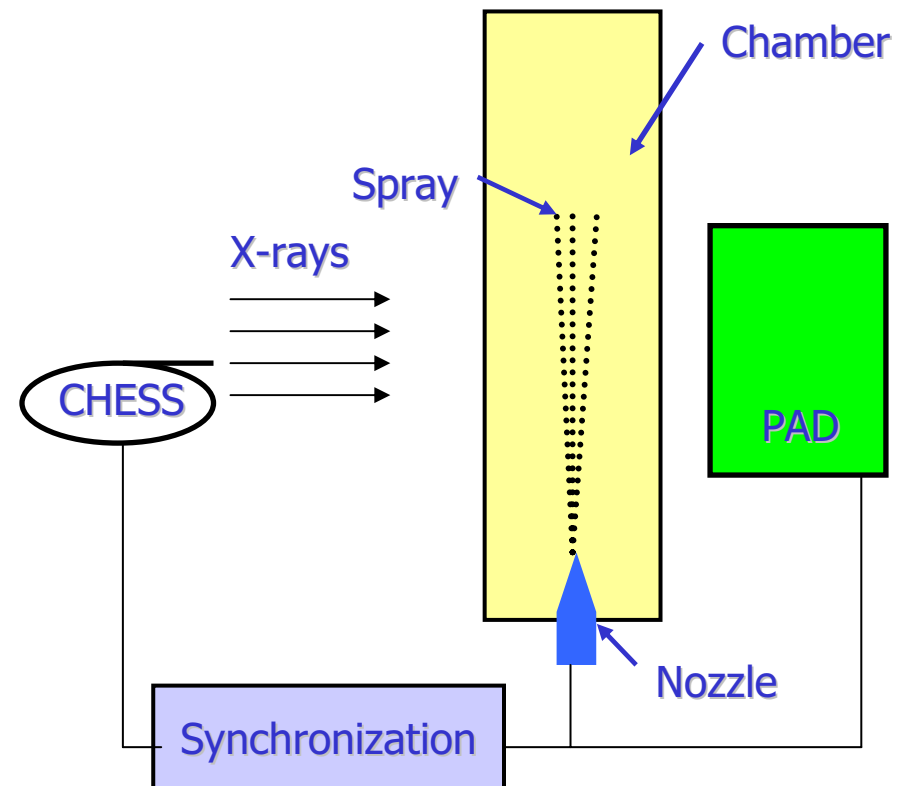
## Diesel Fuel Injection System

- Cerium added for x-ray contrast
- 1350 PSI gas driven
- 1.1 ms pulse
- 1 ATM SF<sub>6</sub> in chamber

Collaboration: Jin Wang (APS) & S.M. Gruner (Cornell)

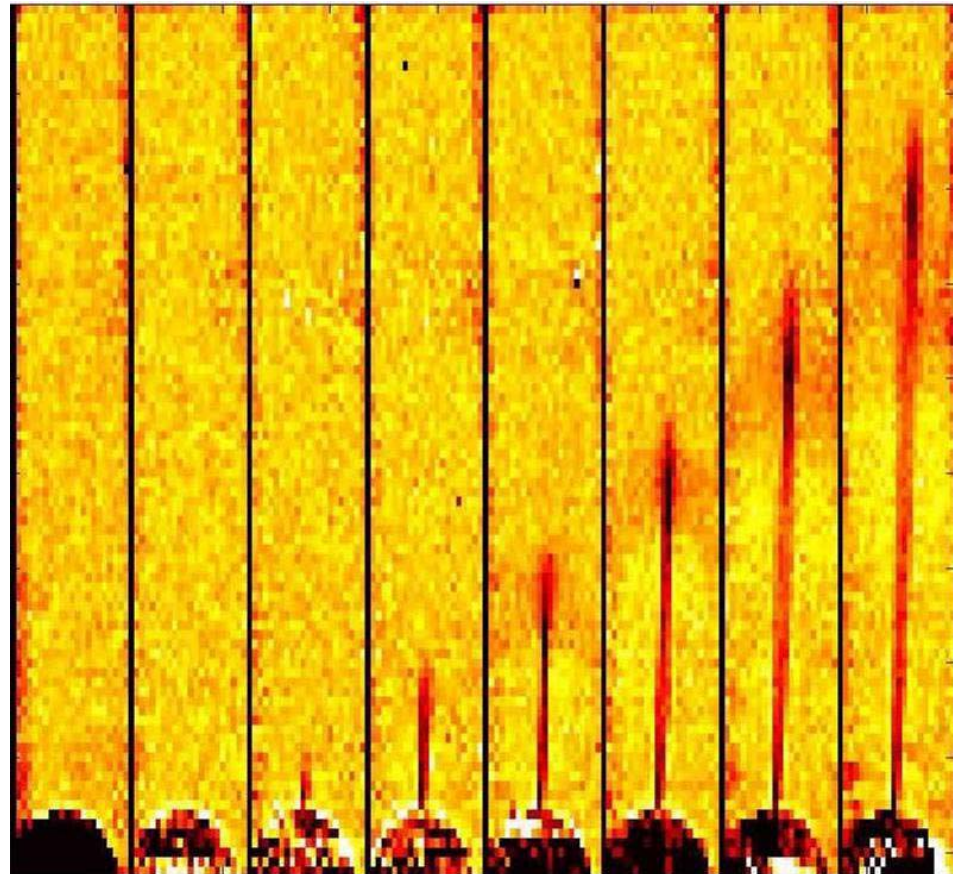
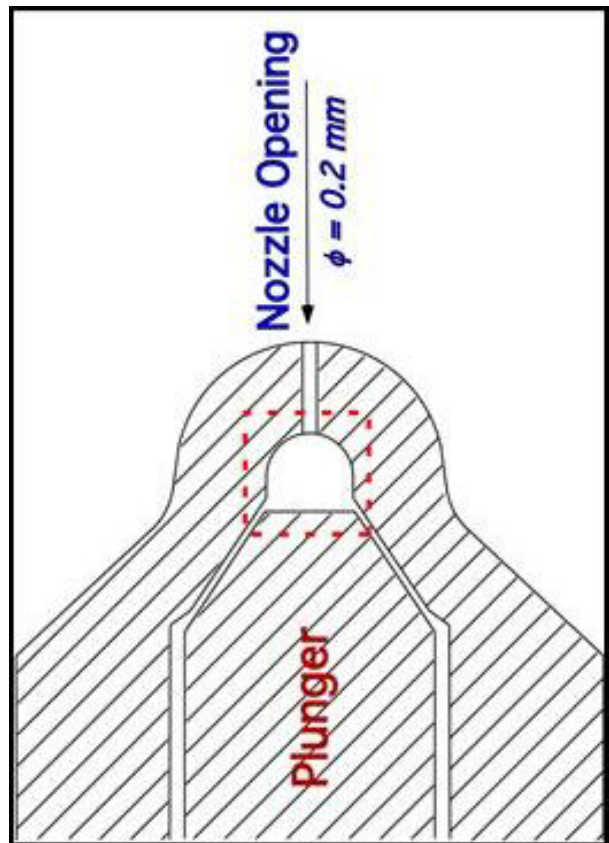
See: McPhee, Tate, Powell, Yue, Renzi, Ercan, Narayanan, Fontes, Walther, Schaller, Gruner & Wang

*Science* 295 (2002) 1261-1263.



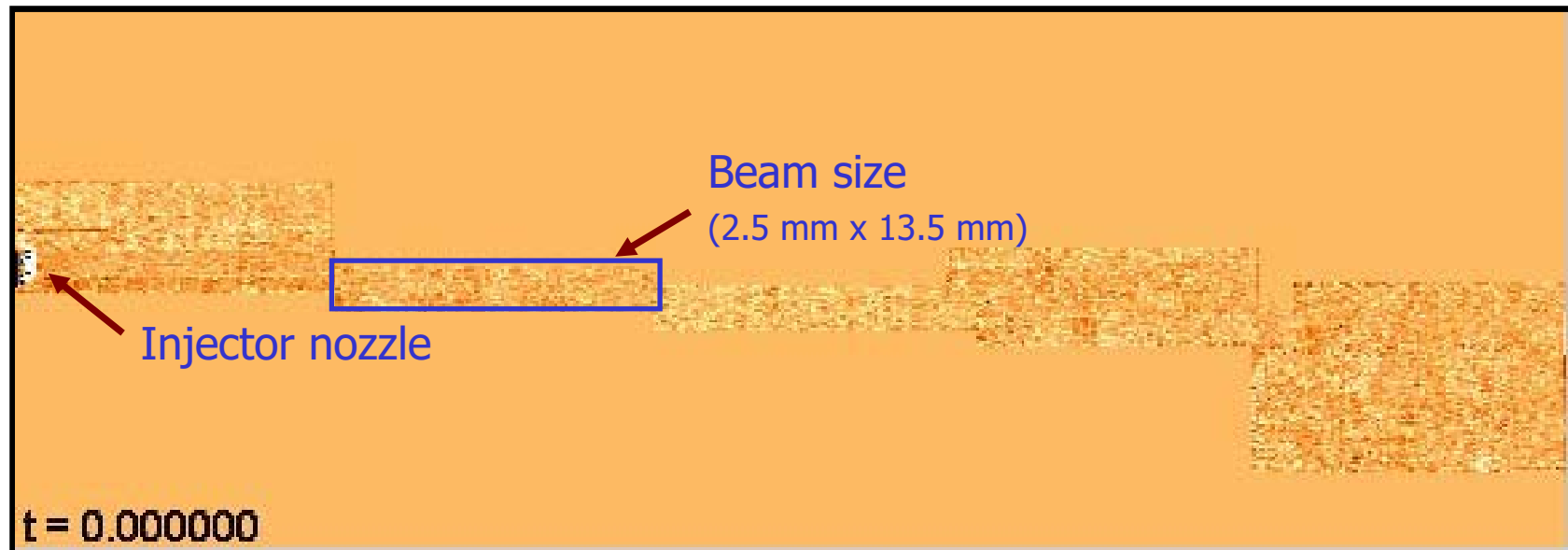


# High speed radiography: Supersonic spray from diesel fuel injector



# Diesel fuel injector spray

- 1.3 ms time sequence (composite of 34 sample positions)
- 5.13  $\mu\text{s}$  exposure time (2.56  $\mu\text{s}$  between frames)
- 168 frames in time (21 groups of 8 frames) Average 20x for S/N
- Sequence comprised of  $5 \times 10^4$  images



A. MacPhee, *et al*, Science (2002). **295**, 1261-1263.



# Gasoline fuel injector spray

## X-ray beam

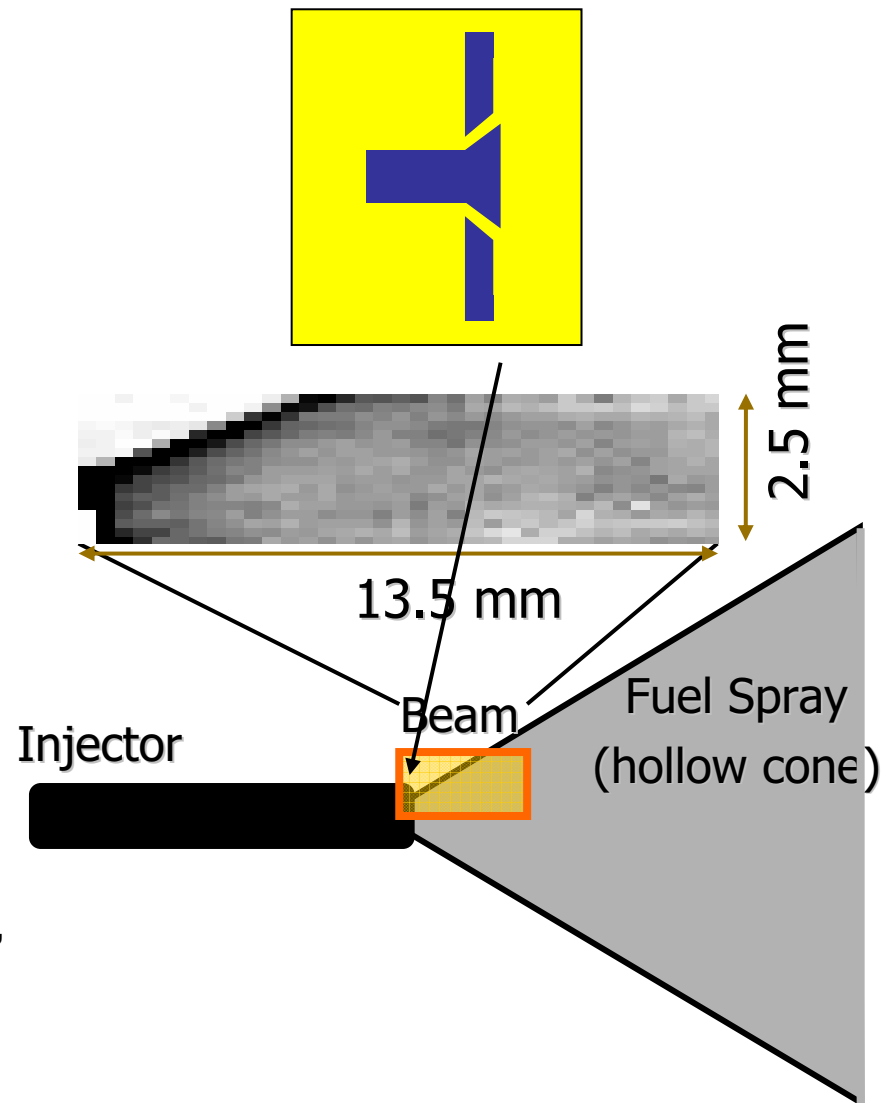
- CHESS Beamline D-1
- 6 keV (1% bandpass)
- 2.5 mm x 13.5 mm
- (step sample to tile large area)
- $10^9$  x-rays/pix/s
- 5.13  $\mu$ s integration (2x ring period)

## Fuel injection system

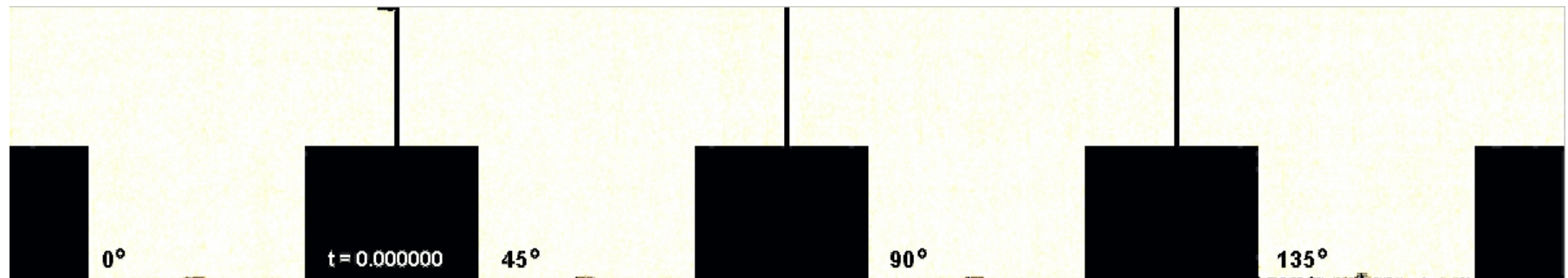
- Cerium added for x-ray contrast
- 1000 PSI gas driven
- 1 ms pulse
- 1 ATM Nitrogen

**Collaboration: Jin Wang (APS) & S.M. Gruner (Cornell)**

See: Cai, Powell, Yue, Narayanan, Wang, Tate, Renzi, Ercan, Fontes & Gruner  
Appl. Phys. Lett. 83 (2003) 1671.



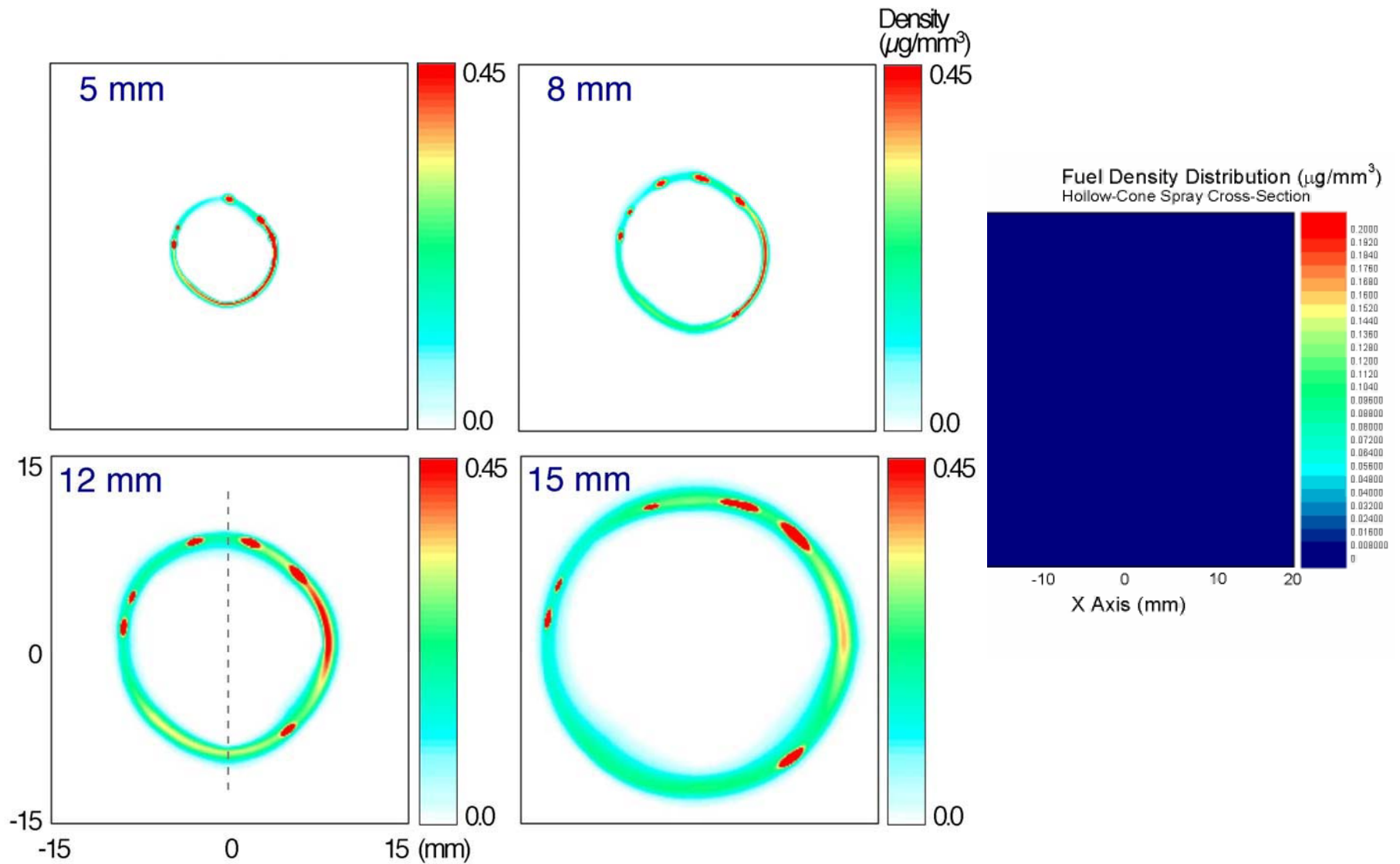
# Gasoline fuel injector spray



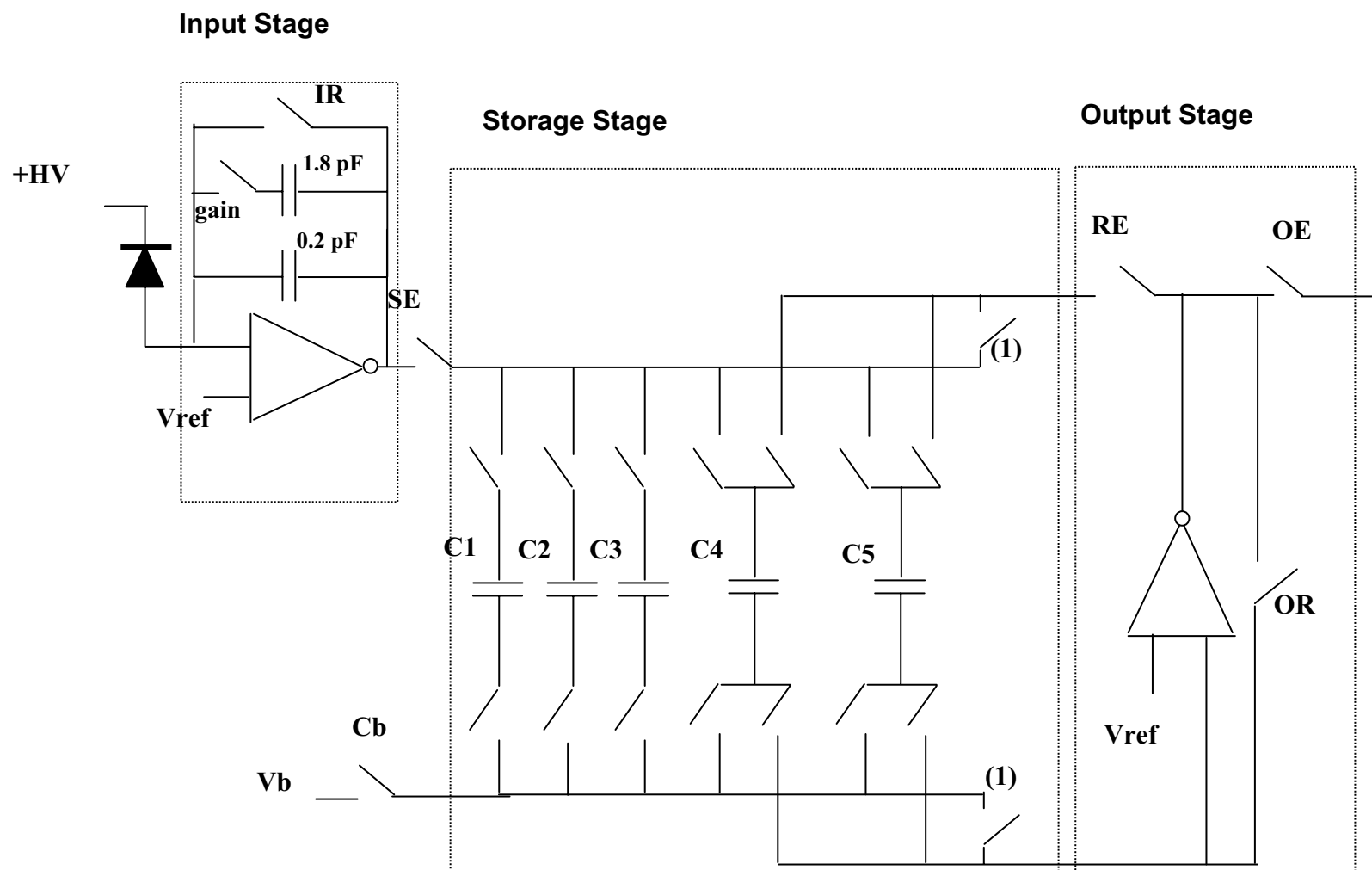
- 1.8 ms time sequence (composite).  $10^5$  images
- 5.13  $\mu\text{s}$  exposure time. (15.4  $\mu\text{s}$  between frames)
- 88 frames (11 groups of 8 frames), Avg. 20x for noise.
- 1000 x-rays/pixel/ $\mu\text{s}$
- Data taken with 4 projections.

**See poster for more experiments**

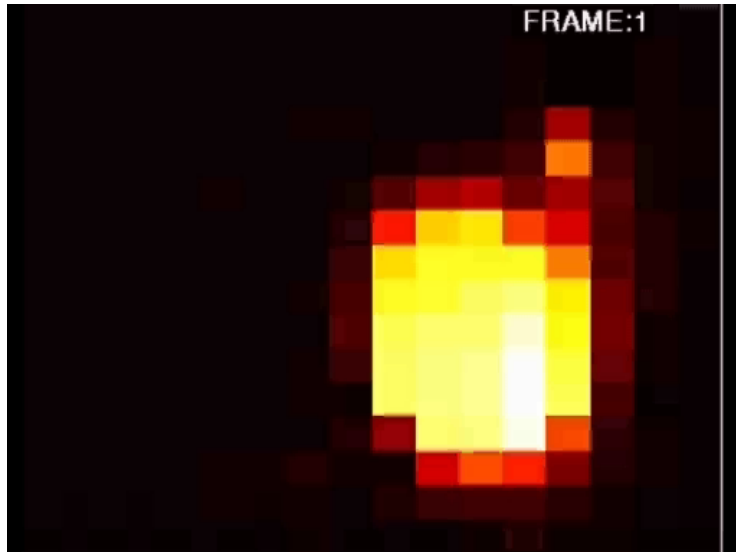
# Spray is very nonuniform



# Faster Duty-Cycle: Push-Pull Configuration with Selectable Gain



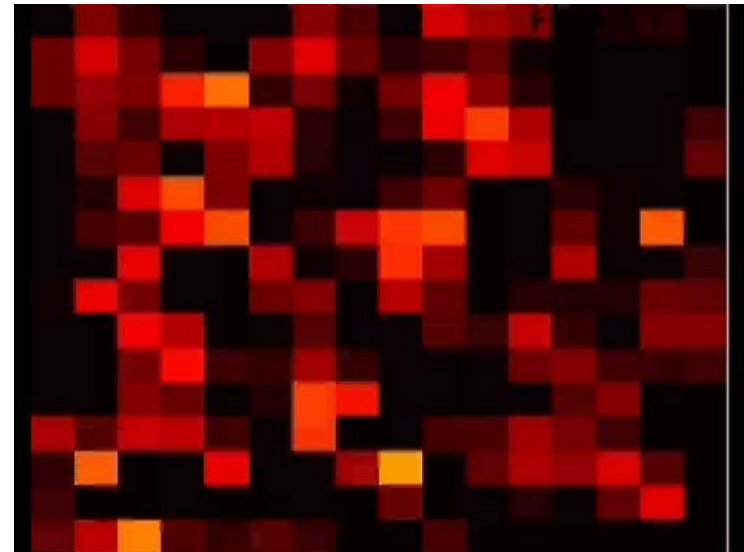
# 16x16 Push-Pull laser tests



**Moving laser spot**

PAD design: Matt Renzi, Alper Ercan

Tests: Alper Ercan



**Laser shining  
through chalk dust  
water.**

**120 frames/sec**

## Mixed-Mode Motivation

- **Calibration issues limit accuracy to few tenths percent, e.g., 1 part in 1,000 exceeds state-of-art.**
- **Range of numbers in an image (e.g., SAXS) may span many orders of magnitude.**

**Suggests that users really want to record images that span many orders of magnitude of intensity across the image, but only need few tenths % accuracy at any location.**

# Mixed Mode Pixel

## Crystallography detector:

### Goals:

- Increase dynamic range ( $10^7$  x-rays)
- Keep high count rates ( $>10^8$  Hz)
- Fast framing ( $< 1$ ms dead time)
- 2k x 2k pixels, 150  $\mu$ m pixel size

### Methods:

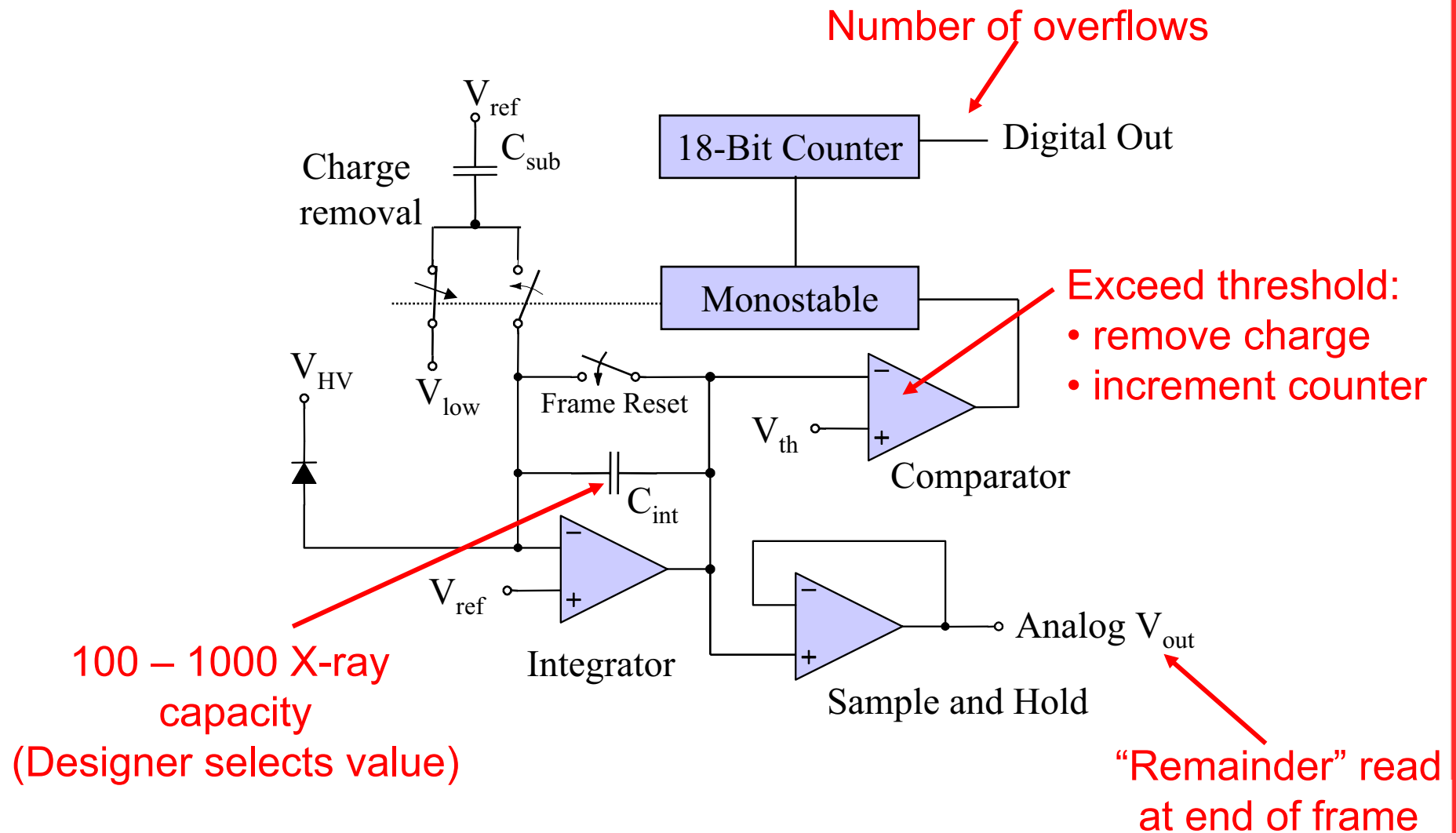
- Integrating pixel w/ digital overflow counter / charge reset
- Analog remainder read at end of frame
- Fabricated in 0.25  $\mu$ m TSMC 3.3 V, metal on metal capacitors

### Collaboration with ADSC. See

S.G. Angello, et al, *IEEE 2004 Nuc. Sci. Symposium*, Rome, (Oct. 16-22, 2004).

# Mixed Mode Pixel

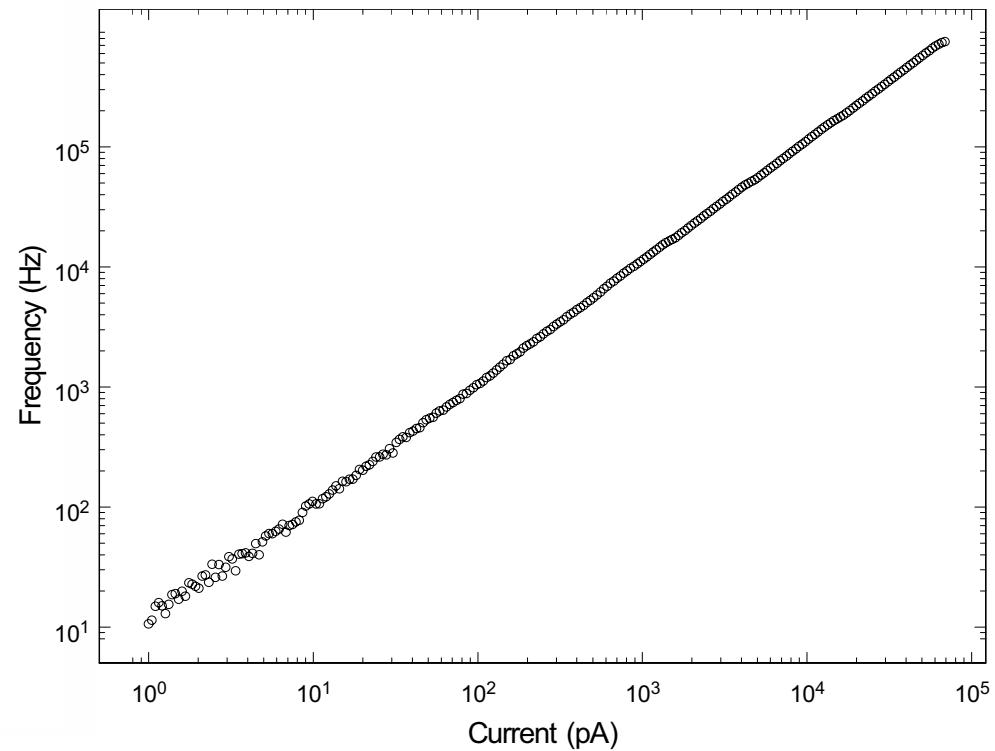
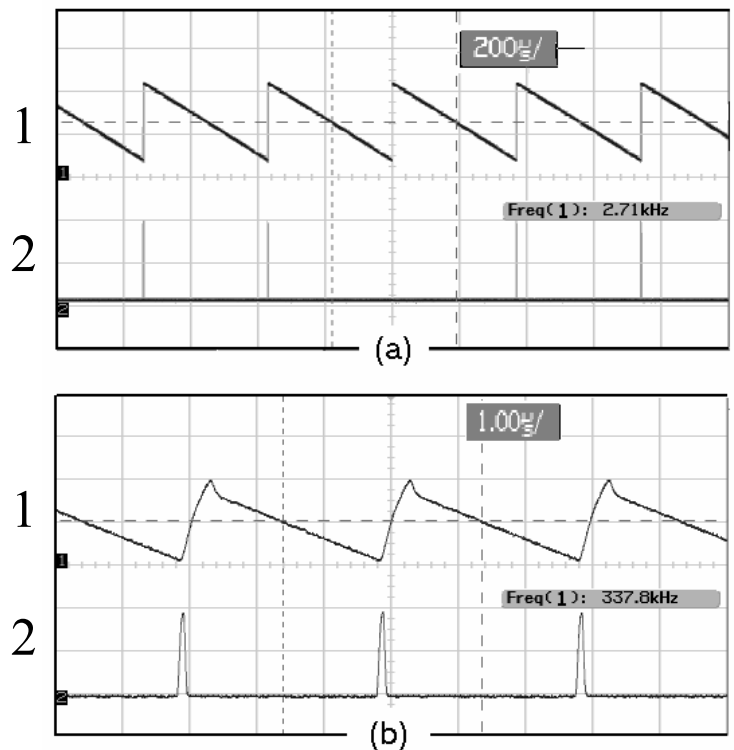
Integrating pixel w/ overflow counter / charge reset





# Mixed Mode Pixel

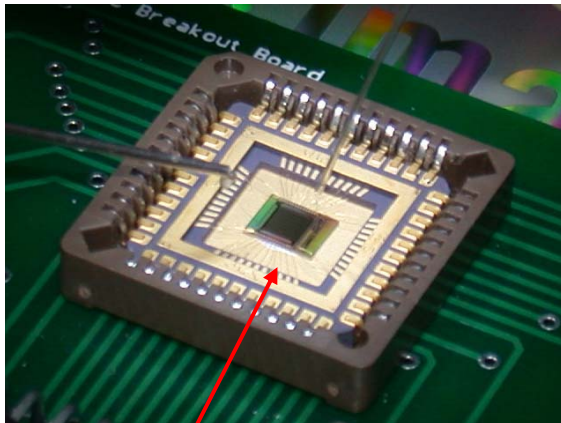
## Pixel Tests



Test Points:      Input current  
 1) Integrator      a) 250 pA  
 2) Comparator     b) 30 nA

Input Current vs. Reset Frequency

# Mixed Mode Pixel



16 x 16 array

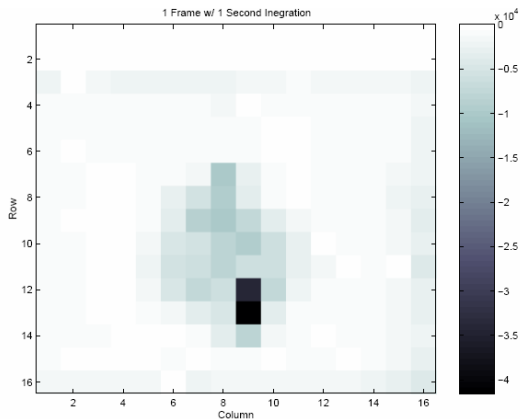
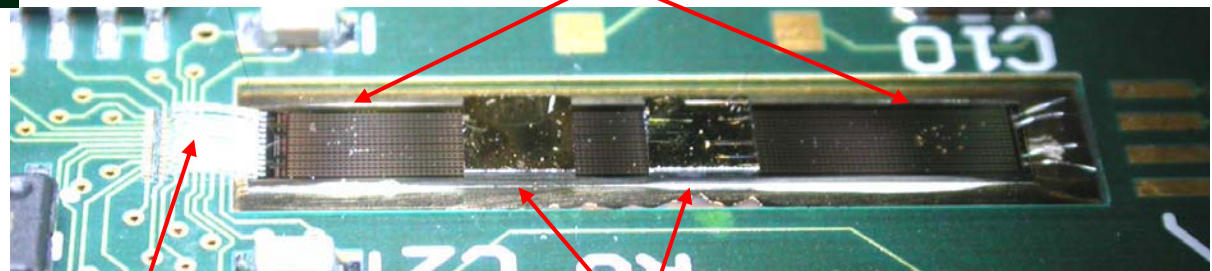


Image of spot projected on 16 x 16 array

## Array testing:

- Pixel addressing
- Crosstalk
- Power distribution
- Imaging



16 x 128 array

Wire bonds  
16 pixel footprint

16 x 16 diodes

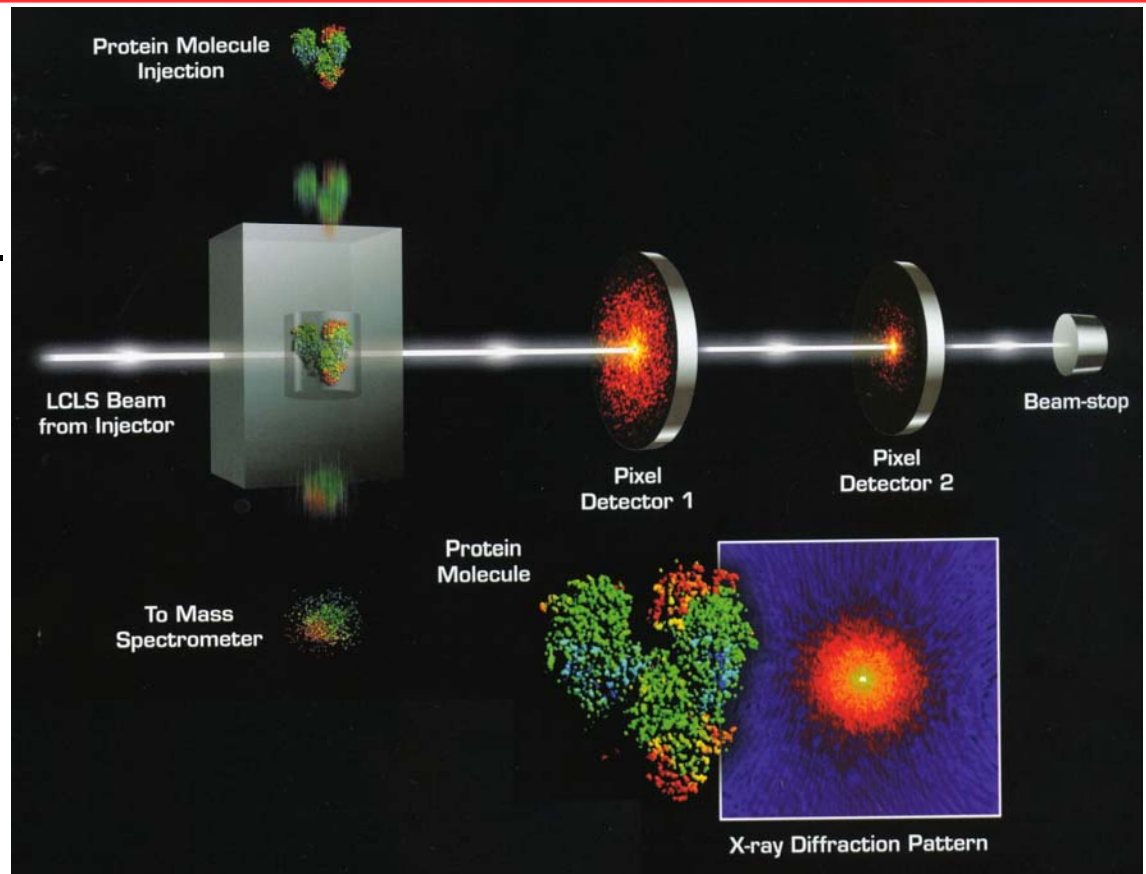
Next step: 128x128 arrays  
replicating 16x128 units on single die

# Integrating PAD for LCLS

## Single Particle Imaging

### Imaging requirements

- Large solid angle coverage
  - <230 fs pulses. Perhaps 2fs.
  - 120 Hz framing
  - $10^{12}$  x-rays/pulse
  - 0 – 1000 x-rays / pixel
- Distinguish between  
0 and 1 x-ray



Pixel detector 1: Wide angle

$S/N$  per x-ray  $\gg 1$

Dynamic range  $\sim 10^3$

$> 512 \times 512$  pixels

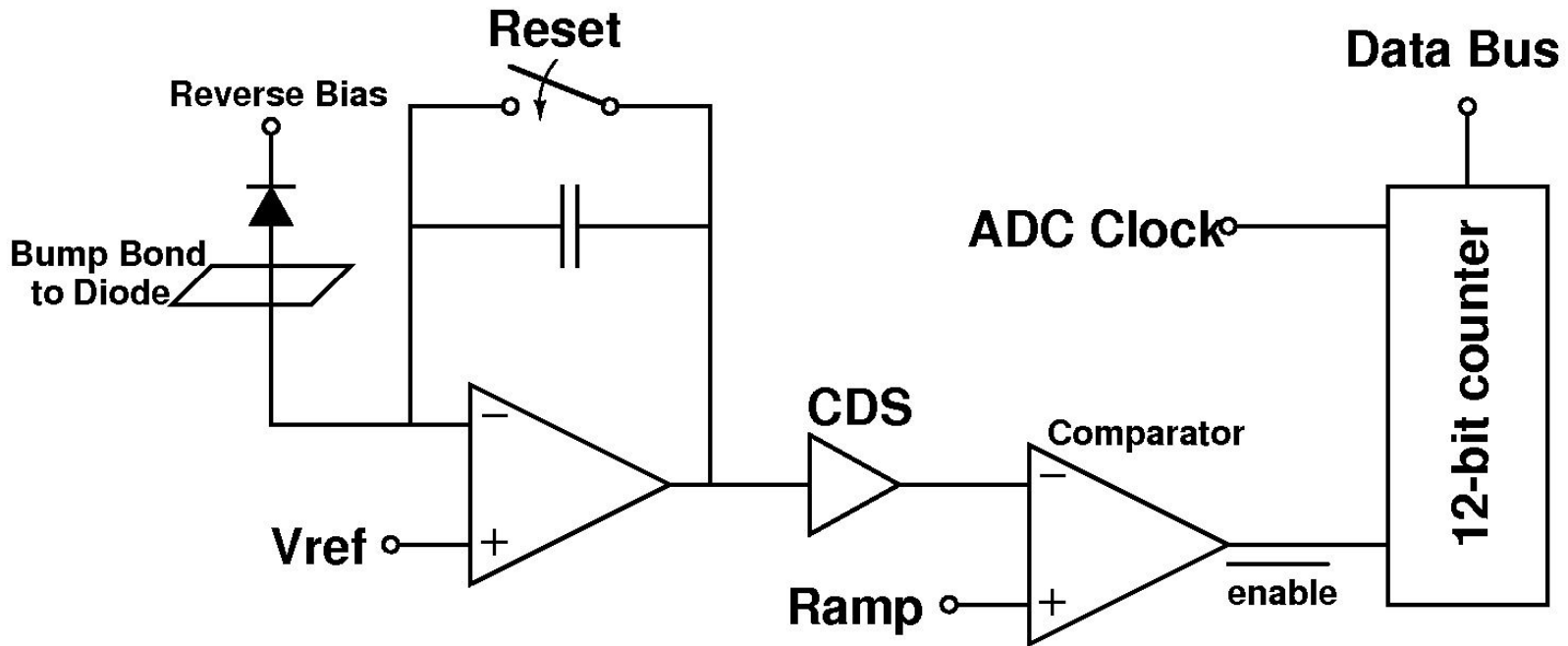
Pixel detector 2: Small angle

$S/N$  per x-ray  $\sim 1$

Dynamic range  $\sim 10^3 - 10^4$

$> 512 \times 512$  pixels

# Integrating PAD for LCLS Pixel Schematic



Increase S/N for low dose  
Smaller full well  
CDS circuitry

1 ADC per pixel

1<sup>st</sup> Fabrication: October 2005

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